



ESP

Electronic Systems Packaging





In the late 1960s, Electronic Stamping Corporation was established in Gardena, California to provide precision miniature metal stampings to the electronics industry. In the late 1970s, **Electronic Systems Packaging** (ESP) was formed under Electronic Stamping Corporation in Rancho Dominguez, California to accommodate the growing needs for interconnecting devices in high power applications. ESP broke away from Electronic Stamping Corporation in 1998 and became a separate entity to concentrate its efforts on manufacturing bus bars. Today, ESP manufactures bus bars, IGBTs, magnet assemblies, and other products for the defense and commercial industries.

ESP's bus bar design goals are to provide its customers with overall lower assembly costs, assembly error reduction, space savings and inductance reduction. ESP strives to achieve superior product integrity and customer satisfaction.

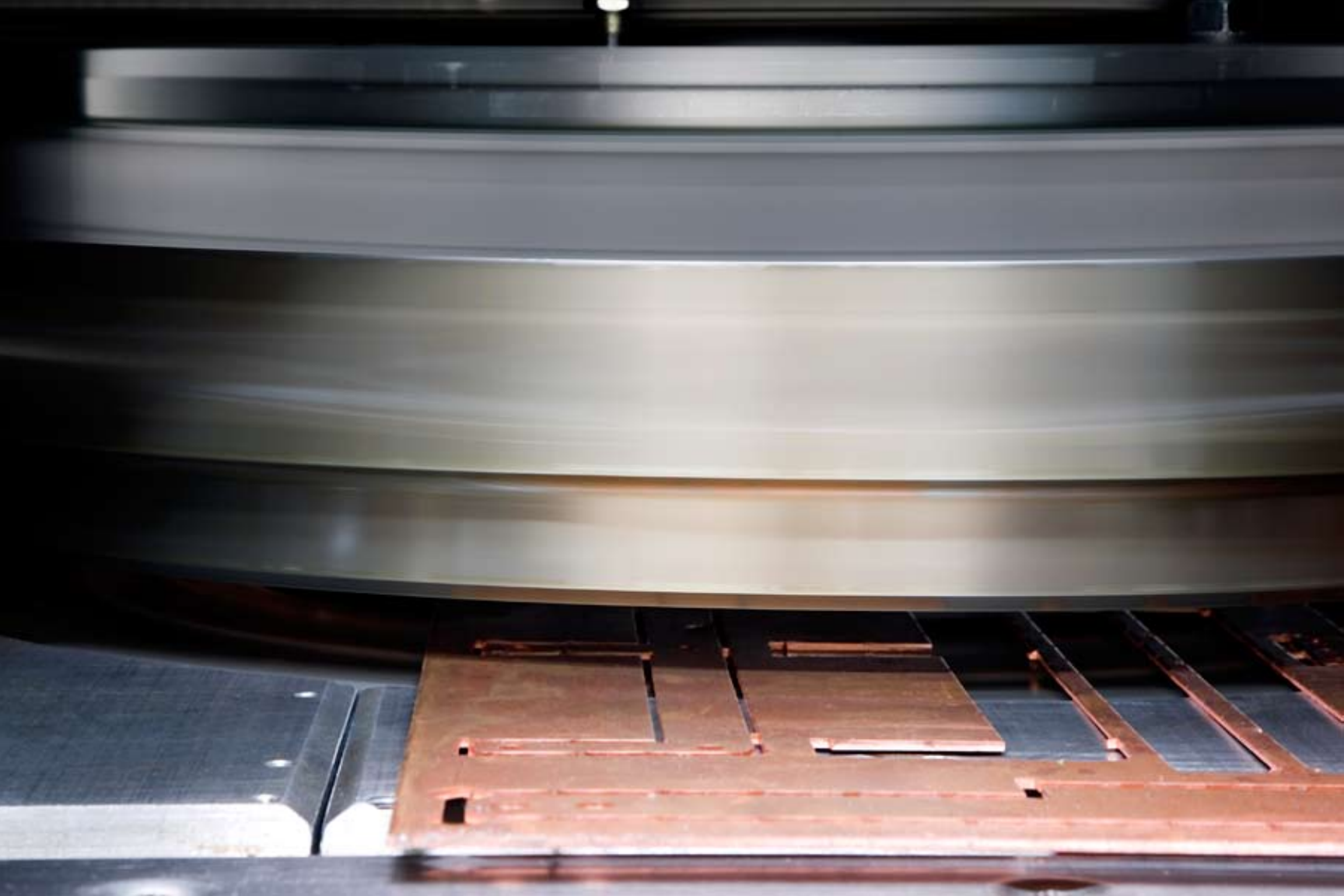
DESIGN/ASSEMBLY

With the radically increasing circuit requirements of today's high-density designs, the need for more sophisticated interconnect technology is required. ESP can provide **custom interconnect solutions** to meet your needs.



We know what works!
We can assist in evaluating your design and
material selection for cost-effective production.
Send in your request for quotation today.



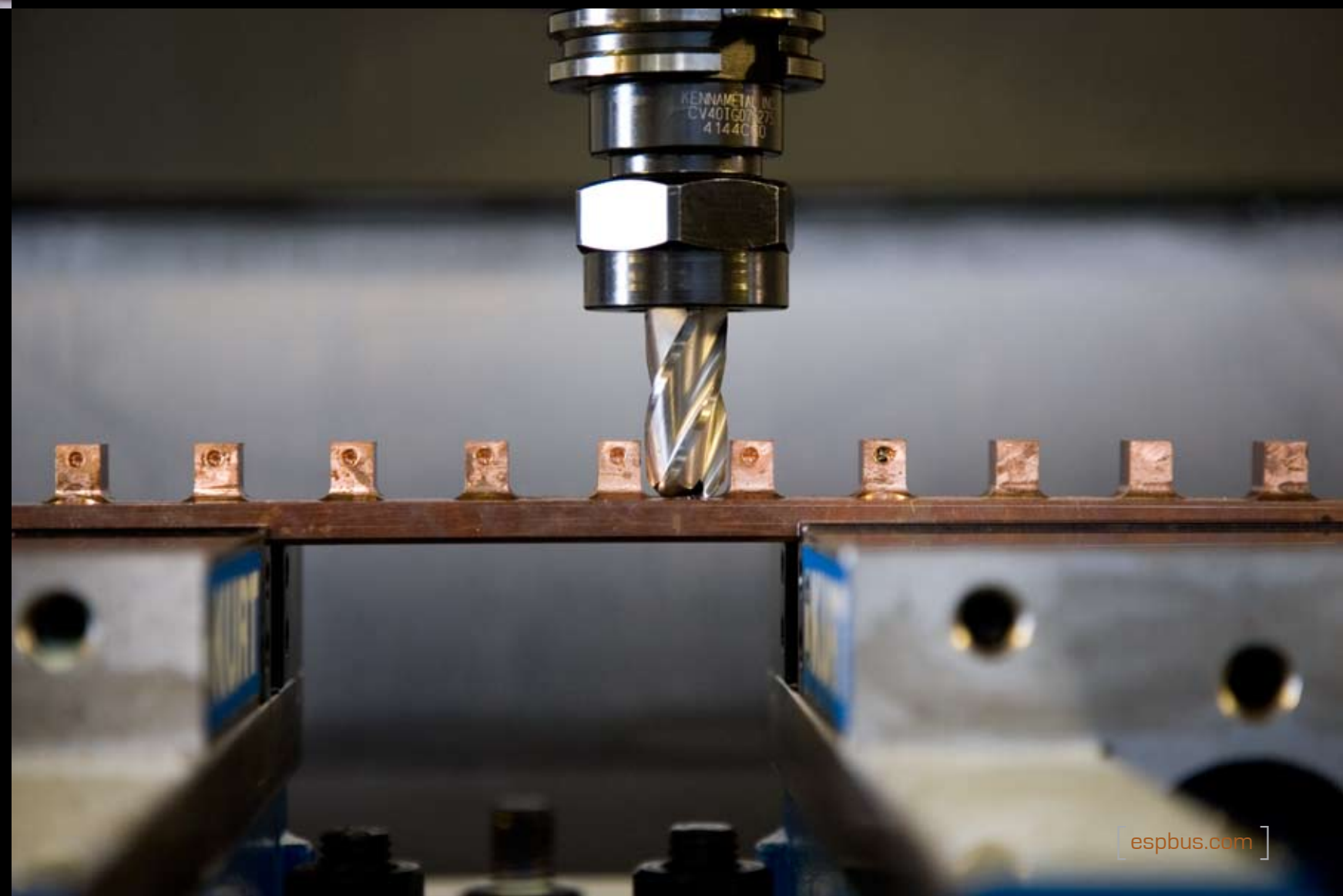


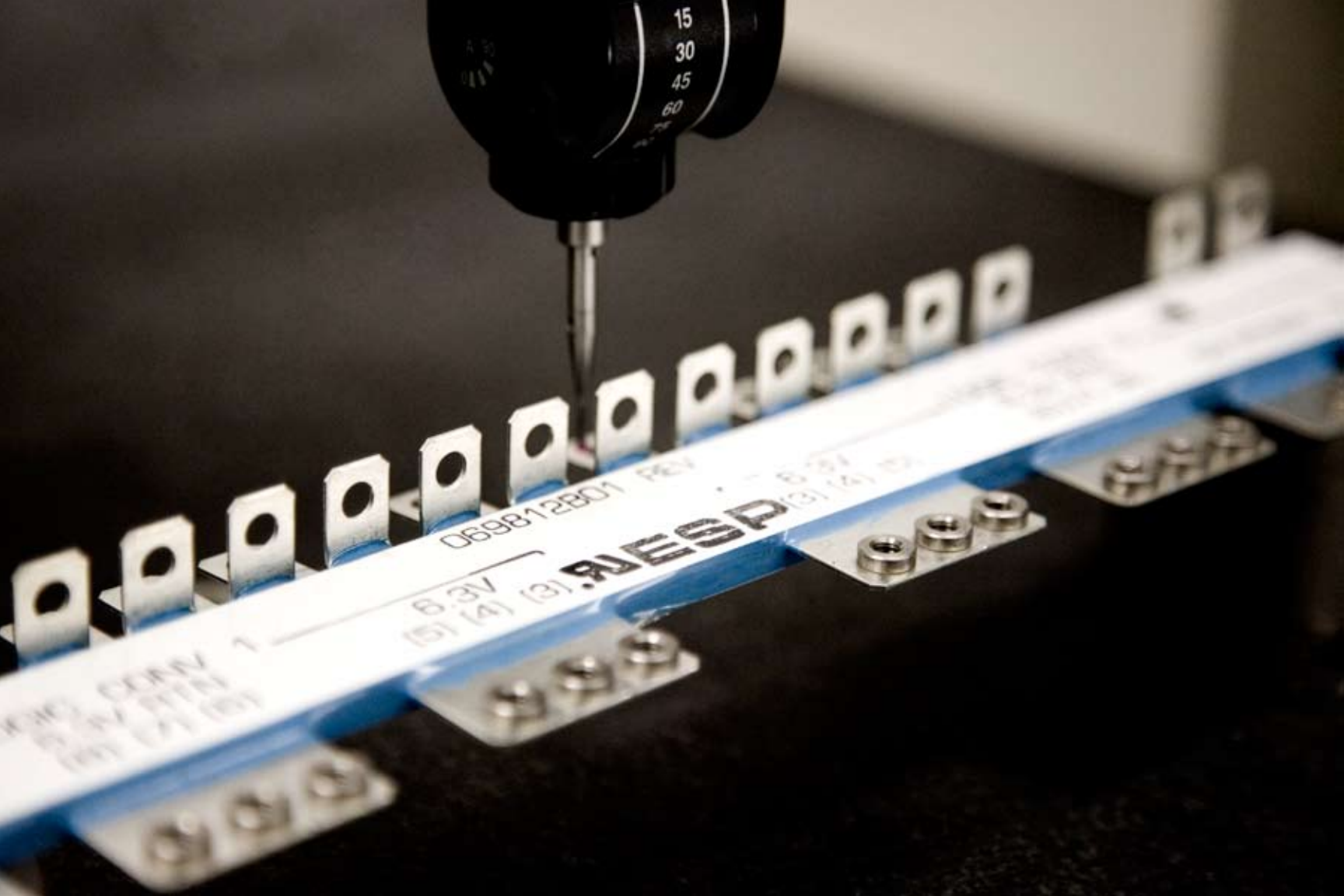
CNC METAL FABRICATION

ESP has over 20 years of experience in CNC metal stamping and forming.

MACHINING

ESP has a full in-house CNC machining capability.





INSPECTION

ESP is capable of providing full inspection data using the finest CMM equipment.

ADDITIONAL MANUFACTURING PROCESSES

Soldering

Spot Welding

Arc Welding

Brazing

Plasma Cutting

Third-Party System Integration